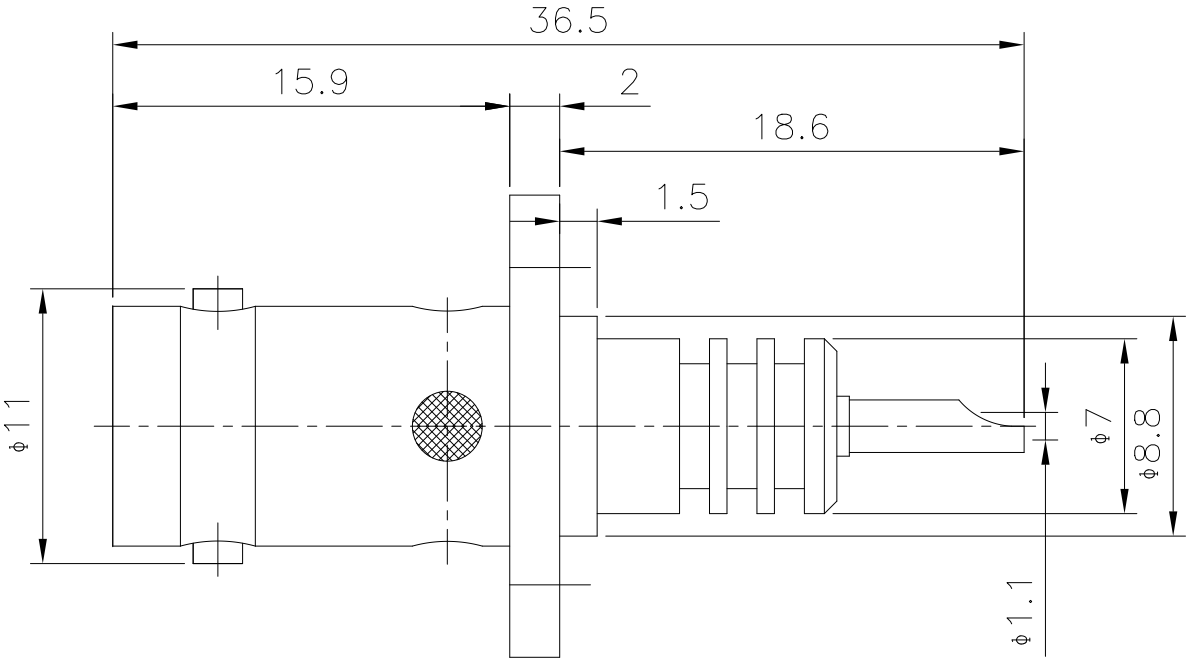
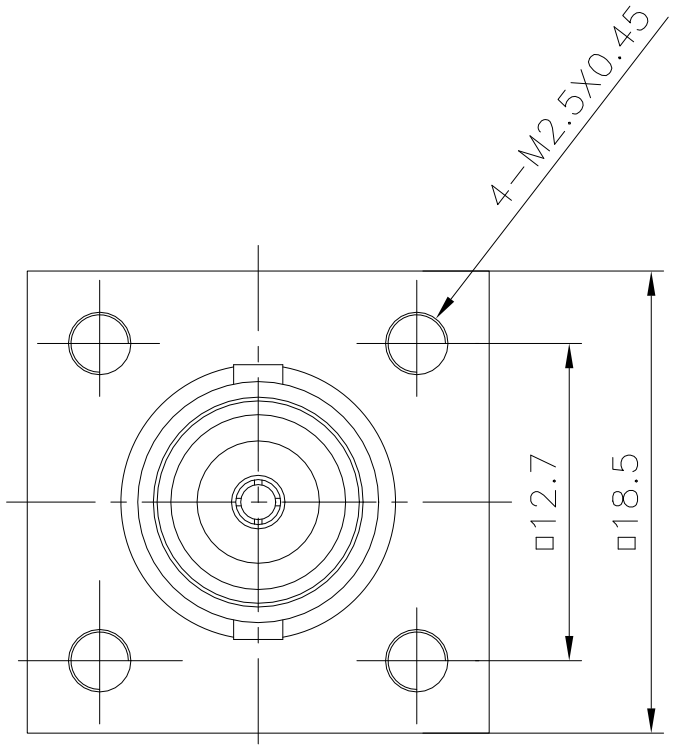
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
1			INITIAL RELEASE	24/01.05	Yy_D
3			UPDATE P/N	24/04,08	Yy_D





电气/机械指标要求

阻抗	频率(GHz)	VSWR<	IL<	PIM<	耐压	绝缘电阻>	抗拉强度
50	0~2G	1.15	/	/	1000V	5000MΩ	

5704BZ-020 R 0 0 0 0 R-TJ

- T: TRAY
- R: REEL
- R:RoHS
- H:HALOGEN-FREE
- BNC

技术要求:

1. 材质符合RoHS;
2. 内导体劈槽需与法兰任意面平行.
3. 外导体黄铜HPb59-1镀镍2um MIN,内导体铍青铜(QBe2)镀金0.15u
4. 满足96H盐雾要求

DIM	TOL
X.	±0.35
.X	±0.30
.XX	±0.25

DIM	TOL
X.	±2°
.X	±1°

DEREN
SHENZHEN DEREN ELECTRONIC CO.,LTD

DRAW NO.	C-DWG:	TJ	DATE
SCXXXXXXX-X	DESIGN:	Yy_D	24/04,08
	CHECK:		
REV. 3	APPROVAL:		

TITLE: BNC HT-MHV-JACK CONN
P/N:
SHEET: 1/1
SCALE: N/A UNIT: mm